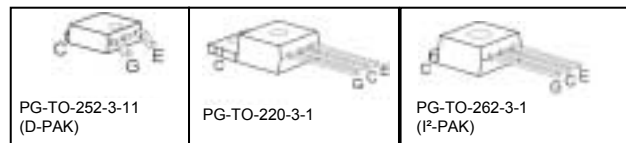
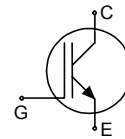


## Fast IGBT in NPT-technology

- 40% lower  $E_{off}$  compared to previous generation
- Short circuit withstand time – 10  $\mu$ s
- Designed for:
  - Motor controls
  - Inverter
  - SMPS
- NPT-Technology offers:
  - very tight parameter distribution
  - high ruggedness, temperature stable behaviour
  - parallel switching capability
- Qualified according to JEDEC<sup>1</sup> for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>



Type	$V_{CE}$	$I_C$	$E_{off}$	$T_j$	Marking	Package
SGP02N120	1200V	2A	0.11mJ	150°C	GP02N120	PG-TO-220-3-1
SGD02N120	1200V	2A	0.11mJ	150°C	02N120	PG-TO-252-3-11
SGI02N120	1200V	2A	0.11mJ	150°C	GI02N120	PG-TO-262-3-1

### Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{CE}$	1200	V
DC collector current	$I_C$	6.2	A
$T_C = 25^\circ\text{C}$		2.8	
$T_C = 100^\circ\text{C}$		9.6	
Pulsed collector current, $t_p$ limited by $T_{jmax}$	$I_{Cpuls}$	9.6	
Turn off safe operating area	-	9.6	
$V_{CE} \leq 1200\text{V}, T_j \leq 150^\circ\text{C}$			
Gate-emitter voltage	$V_{GE}$	$\pm 20$	V
Avalanche energy, single pulse	$E_{AS}$	10	mJ
$I_C = 2\text{A}, V_{CC} = 50\text{V}, R_{GE} = 25\Omega$ , start at $T_j = 25^\circ\text{C}$			
Short circuit withstand time <sup>2</sup>	$t_{SC}$	10	$\mu$ s
$V_{GE} = 15\text{V}, 100\text{V} \leq V_{CC} \leq 1200\text{V}, T_j \leq 150^\circ\text{C}$			
Power dissipation	$P_{tot}$	62	W
$T_C = 25^\circ\text{C}$			
Operating junction and storage temperature	$T_j, T_{stg}$	-55...+150	$^\circ\text{C}$
Soldering temperature, PG-TO252 (reflow soldering, MSL3)	-	260	
Other packages: 1.6mm (0.063 in.) from case for 10s		260	

<sup>1</sup> J-STD-020 and JESD-022

<sup>2</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

### Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
<b>Characteristic</b>				
IGBT thermal resistance, junction – case	$R_{thJC}$		2.0	K/W
Thermal resistance, junction – ambient	$R_{thJA}$	PG-TO-220-3-1 PG-TO-262-3-1	62	
SMD version, device on PCB <sup>1)</sup>	$R_{thJA}$	PG-TO-252-3-11	50	

### Electrical Characteristic, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>Static Characteristic</b>						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_C=100\mu A$	1200	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE} = 15V, I_C=2A$ $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	2.5 -	3.1 3.7	3.6 4.3	
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_C=100\mu A, V_{CE}=V_{GE}$	3	4	5	
Zero gate voltage collector current	$I_{CES}$	$V_{CE}=1200V, V_{GE}=0V$ $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	- -	- -	25 100	$\mu A$
Gate-emitter leakage current	$I_{GES}$	$V_{CE}=0V, V_{GE}=20V$	-	-	100	nA
Transconductance	$g_{fs}$	$V_{CE}=20V, I_C=2A$		1.5	-	S
<b>Dynamic Characteristic</b>						
Input capacitance	$C_{iss}$	$V_{CE}=25V,$ $V_{GE}=0V,$ $f=1\text{MHz}$	-	205	250	pF
Output capacitance	$C_{oss}$		-	20	25	
Reverse transfer capacitance	$C_{riss}$		-	12	14	
Gate charge	$Q_{Gate}$	$V_{CC}=960V, I_C=2A$ $V_{GE}=15V$	-	11	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	$L_E$		-	7	-	nH
Short circuit collector current <sup>2)</sup>	$I_{C(SC)}$	$V_{GE}=15V, t_{SC}\leq 10\mu s$ $100V\leq V_{CC}\leq 1200V,$ $T_j\leq 150^\circ\text{C}$	-	24	-	A

<sup>1)</sup> Device on 50mm\*50mm\*1.5mm epoxy PCB FR4 with 6cm<sup>2</sup> (one layer, 70μm thick) copper area for collector connection. PCB is vertical without blown air.

<sup>2)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

**Switching Characteristic, Inductive Load, at  $T_j=25^\circ\text{C}$**

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>IGBT Characteristic</b>						
Turn-on delay time	$t_{d(on)}$	$T_j=25^\circ\text{C}$ , $V_{CC}=800\text{V}$ , $I_C=2\text{A}$ , $V_{GE}=15\text{V}/0\text{V}$ , $R_G=91\Omega$ , $L_\sigma^{(1)}=180\text{nH}$ , $C_\sigma^{(1)}=40\text{pF}$ Energy losses include "tail" and diode reverse recovery.	-	23	30	ns
Rise time	$t_r$		-	16	21	
Turn-off delay time	$t_{d(off)}$		-	260	340	
Fall time	$t_f$		-	61	80	
Turn-on energy	$E_{on}$		-	0.16	0.21	mJ
Turn-off energy	$E_{off}$		-	0.06	0.08	
Total switching energy	$E_{ts}$		-	0.22	0.29	

**Switching Characteristic, Inductive Load, at  $T_j=150^\circ\text{C}$**

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>IGBT Characteristic</b>						
Turn-on delay time	$t_{d(on)}$	$T_j=150^\circ\text{C}$ $V_{CC}=800\text{V}$ , $I_C=2\text{A}$ , $V_{GE}=15\text{V}/0\text{V}$ , $R_G=91\Omega$ , $L_\sigma^{(1)}=180\text{nH}$ , $C_\sigma^{(1)}=40\text{pF}$ Energy losses include "tail" and diode reverse recovery.	-	26	31	ns
Rise time	$t_r$		-	14	17	
Turn-off delay time	$t_{d(off)}$		-	290	350	
Fall time	$t_f$		-	85	102	
Turn-on energy	$E_{on}$		-	0.27	0.33	mJ
Turn-off energy	$E_{off}$		-	0.11	0.15	
Total switching energy	$E_{ts}$		-	0.38	0.48	

<sup>1)</sup> Leakage inductance  $L_\sigma$  and stray capacity  $C_\sigma$  due to dynamic test circuit in figure E.

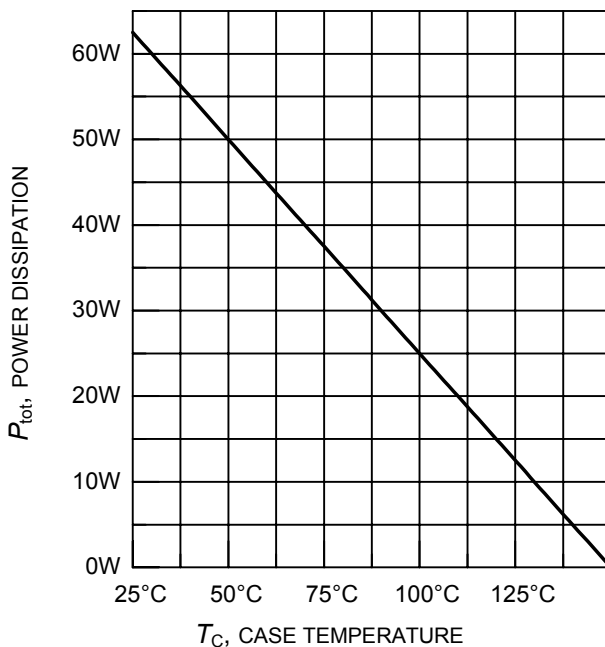


**Figure 1. Collector current as a function of switching frequency**

( $T_j \leq 150^\circ\text{C}$ ,  $D = 0.5$ ,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $R_G = 91\Omega$ )

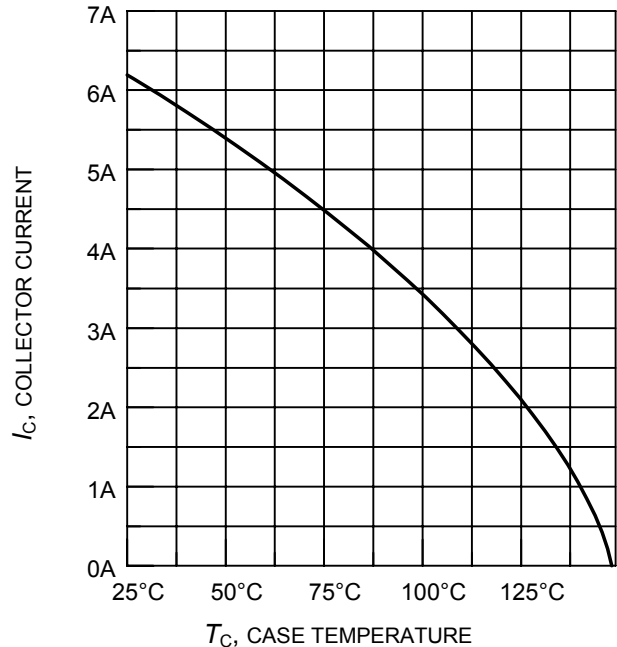


**Figure 2. Safe operating area**  
( $D = 0$ ,  $T_C = 25^\circ\text{C}$ ,  $T_j \leq 150^\circ\text{C}$ )



**Figure 3. Power dissipation as a function of case temperature**

( $T_j \leq 150^\circ\text{C}$ )



**Figure 4. Collector current as a function of case temperature**

( $V_{GE} \leq 15\text{V}$ ,  $T_j \leq 150^\circ\text{C}$ )



**Figure 5. Typical output characteristics**  
( $T_j = 25^\circ\text{C}$ )



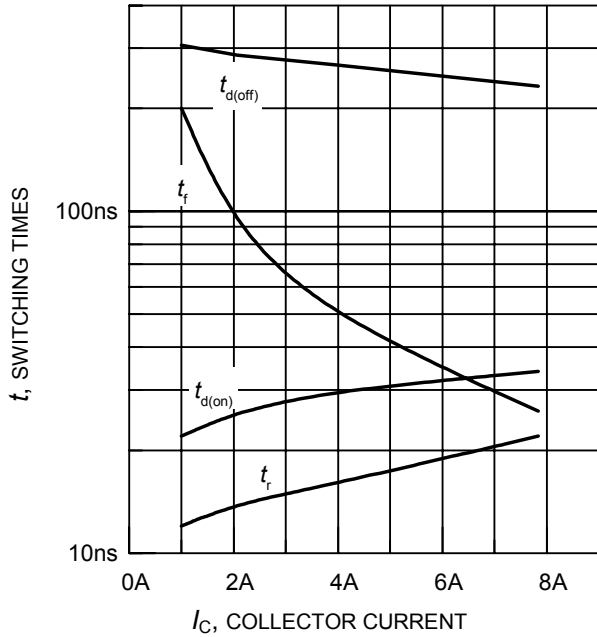
**Figure 6. Typical output characteristics**  
( $T_j = 150^\circ\text{C}$ )



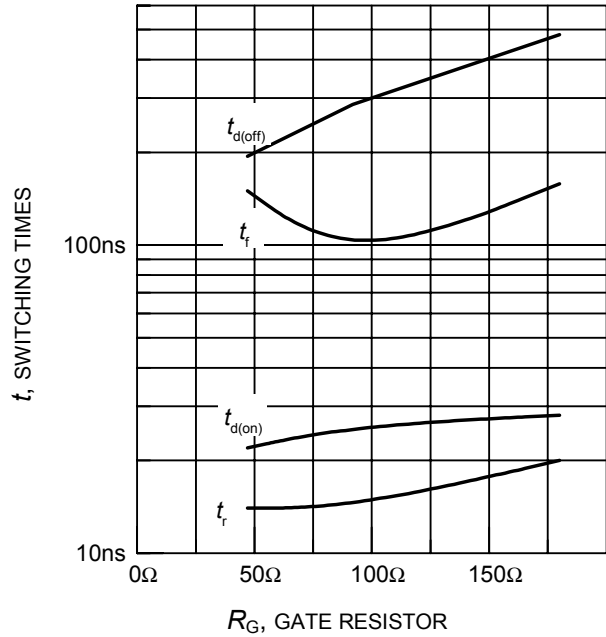
**Figure 7. Typical transfer characteristics**  
( $V_{CE} = 20\text{V}$ )



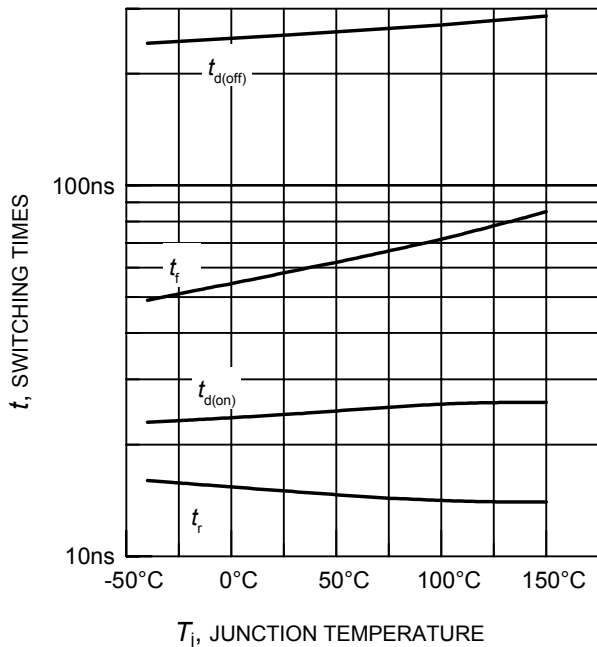
**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE} = 15\text{V}$ )



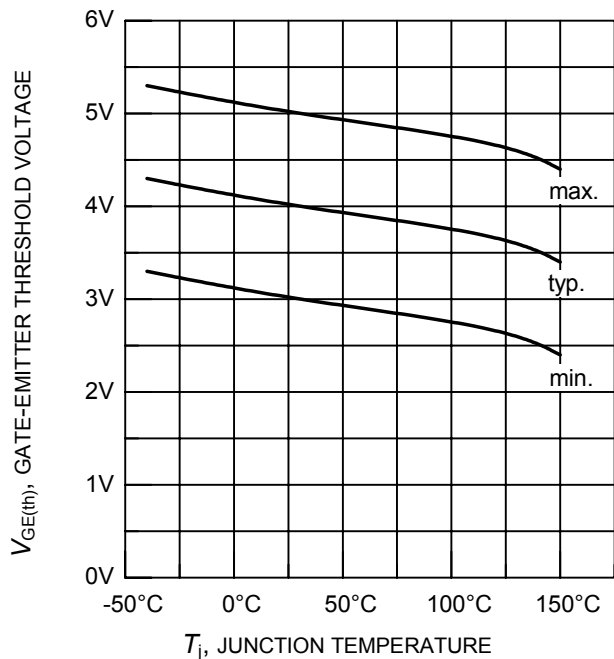
**Figure 9. Typical switching times as a function of collector current**  
 (inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $R_G = 91\Omega$ , dynamic test circuit in Fig.E)



**Figure 10. Typical switching times as a function of gate resistor**  
 (inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 2\text{A}$ , dynamic test circuit in Fig.E)



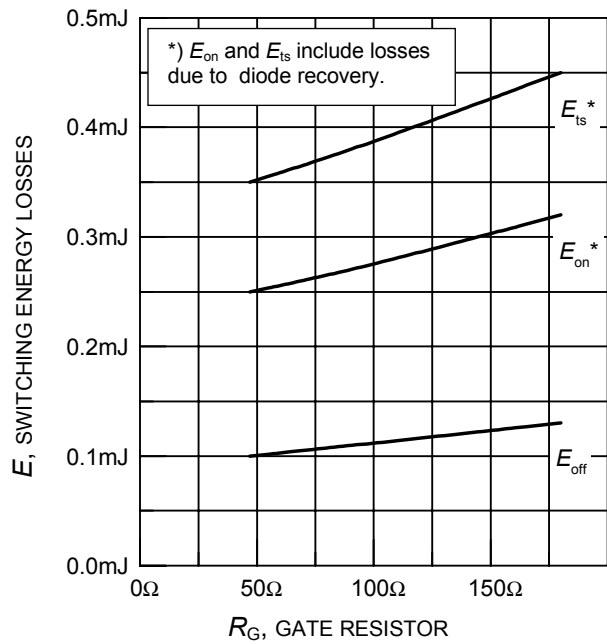
**Figure 11. Typical switching times as a function of junction temperature**  
 (inductive load,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 2\text{A}$ ,  $R_G = 91\Omega$ , dynamic test circuit in Fig.E)



**Figure 12. Gate-emitter threshold voltage as a function of junction temperature**  
 ( $I_C = 0.3\text{mA}$ )



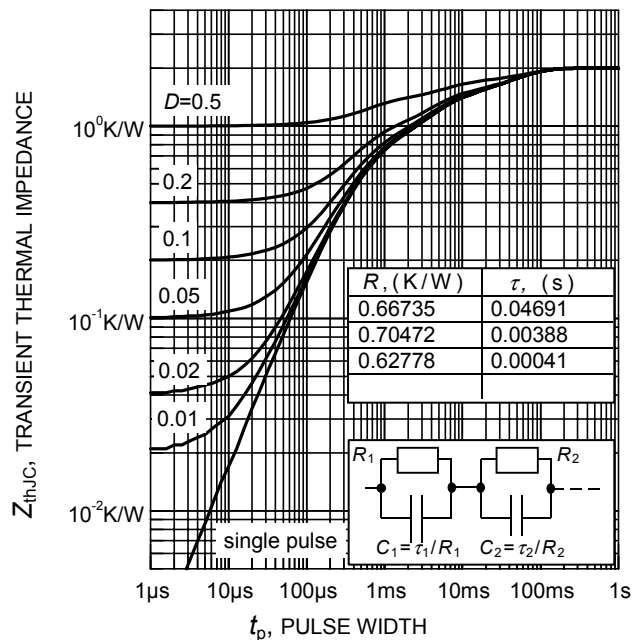
**Figure 13. Typical switching energy losses as a function of collector current**  
(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $R_G = 91\Omega$ , dynamic test circuit in Fig.E )



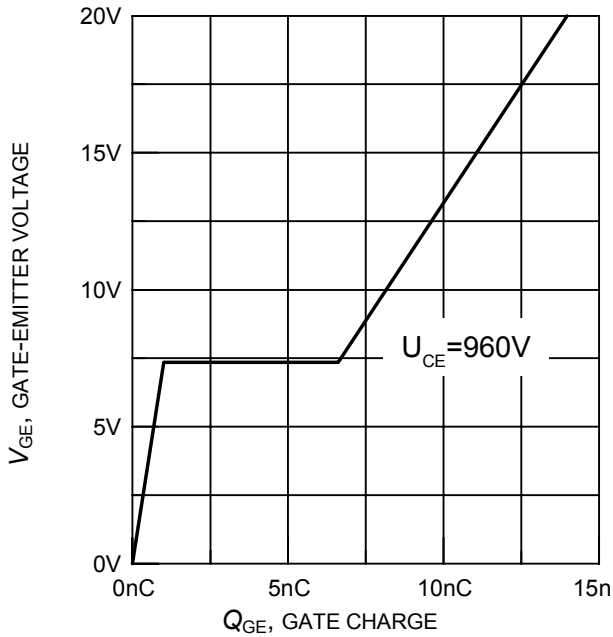
**Figure 14. Typical switching energy losses as a function of gate resistor**  
(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 2\text{A}$ , dynamic test circuit in Fig.E )



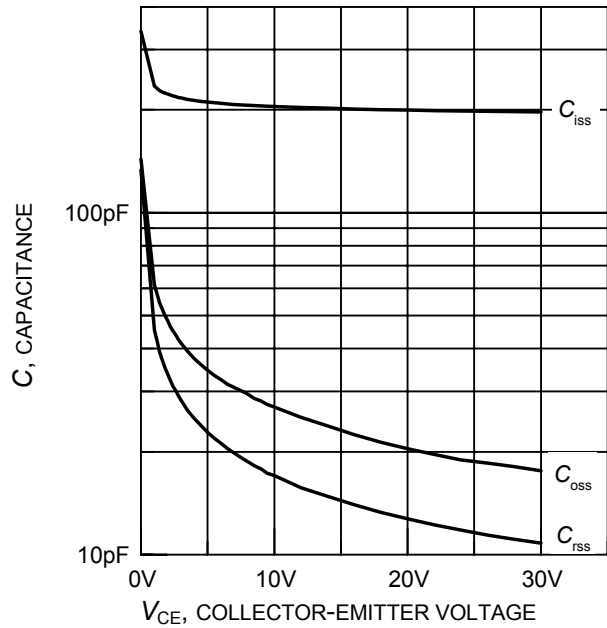
**Figure 15. Typical switching energy losses as a function of junction temperature**  
(inductive load,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 2\text{A}$ ,  $R_G = 91\Omega$ , dynamic test circuit in Fig.E )



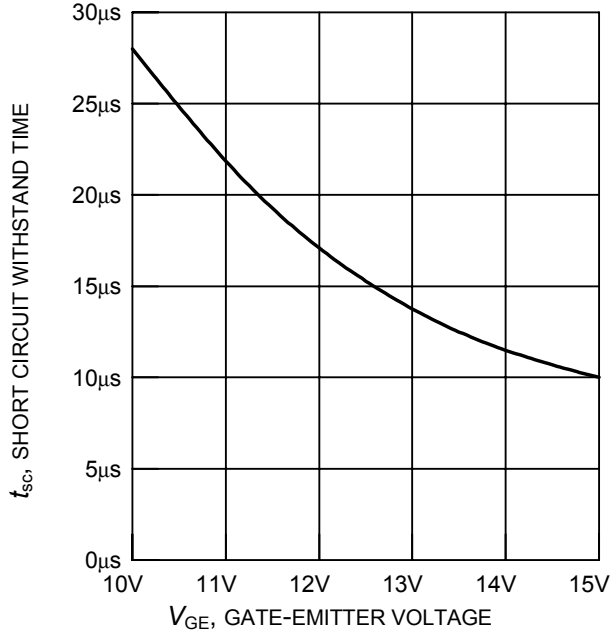
**Figure 16. IGBT transient thermal impedance as a function of pulse width**  
( $D = t_p / T$ )



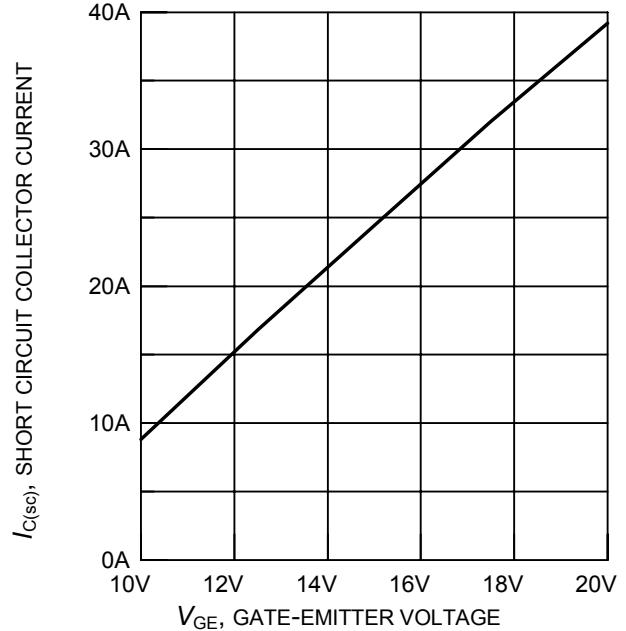
**Figure 17. Typical gate charge**  
( $I_C = 2A$ )



**Figure 18. Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE} = 0V, f = 1MHz$ )



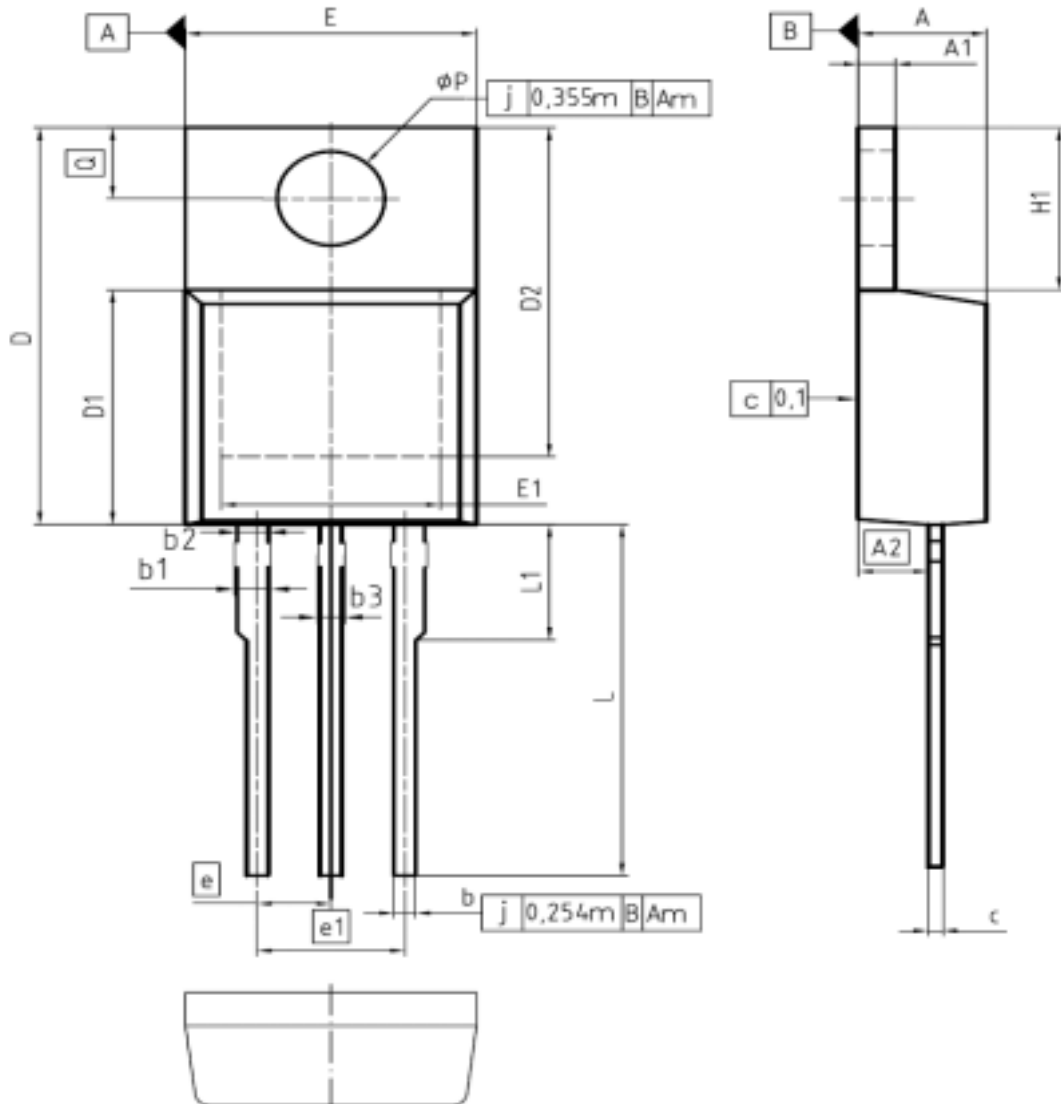
**Figure 19. Short circuit withstand time as a function of gate-emitter voltage**  
( $V_{CE} = 1200V, \text{start at } T_j = 25^\circ C$ )



**Figure 20. Typical short circuit collector current as a function of gate-emitter voltage**  
( $100V \leq V_{CE} \leq 1200V, T_C = 25^\circ C, T_j \leq 150^\circ C$ )



PG-TO220-3-1



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.30	4.57	0.169	0.180
A1	1.17	1.40	0.046	0.055
A2	2.15	2.72	0.085	0.107
b	0.65	0.86	0.026	0.034
b1	0.95	1.40	0.037	0.055
b2	0.95	1.15	0.037	0.045
b3	0.65	1.15	0.026	0.045
c	0.33	0.60	0.013	0.024
D	14.81	15.95	0.583	0.628
D1	8.51	9.45	0.335	0.372
D2	12.19	13.10	0.480	0.516
E	9.70	10.36	0.382	0.408
E1	6.50	8.60	0.256	0.339
e	2.54		0.100	
e1	5.08		0.200	
N	3		3	
H1	5.90	6.90	0.232	0.272
L	13.00	14.00	0.512	0.551
L1	-	4.80	-	0.189
phi P	3.60	3.89	0.142	0.153
Q	2.60	3.00	0.102	0.118

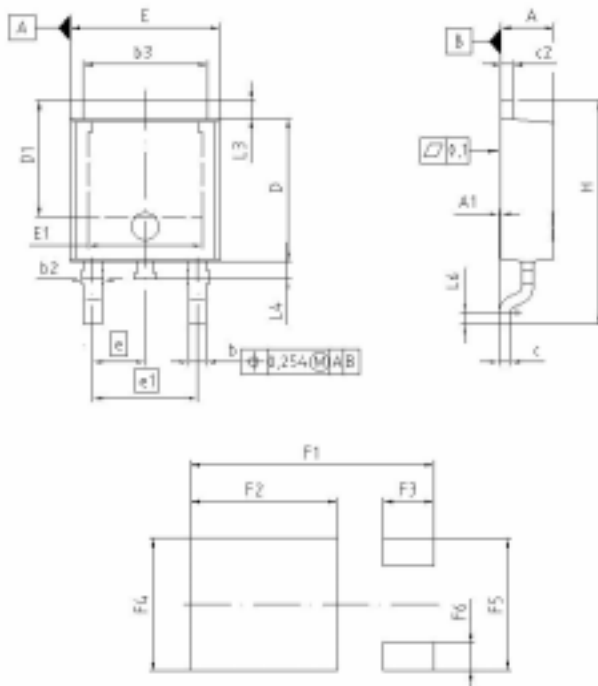
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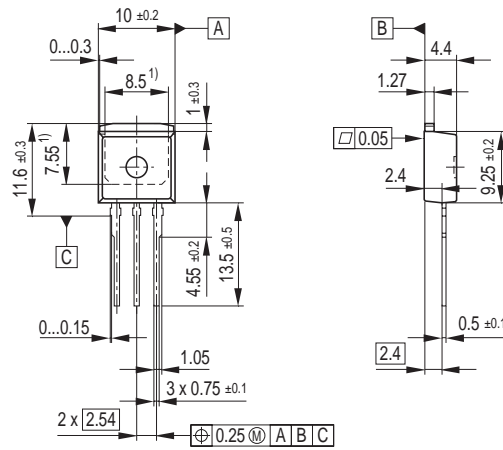
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PG-TO252-3-11

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.194	2.388	0.086	0.094
A1	0.000	0.150	0.000	0.006
b	0.035	0.080	0.005	0.005
b2	0.050	1.450	0.005	0.045
b3	5.000	5.500	0.197	0.217
e	0.400	0.560	0.016	0.023
e2	0.400	0.960	0.016	0.039
D	5.969	6.223	0.235	0.245
D1	5.020	5.320	0.198	0.209
E	6.400	6.724	0.252	0.265
E1	4.900	5.100	0.193	0.201
e	2.298		0.900	
e1	4.572		0.180	
N	S		S	
H	0.400	10.094	0.370	0.397
L3	0.900	1.190	0.035	0.044
L4	0.950	1.010	0.038	0.040
L6	0.510	0.680	0.020	0.027
F1	10.500	10.700	0.413	0.421
F2	6.300	6.500	0.248	0.256
F3	2.800	2.300	0.083	0.091
F4	5.700	5.900	0.224	0.232
F5	5.800	5.800	0.222	0.231
F6	1.100	1.300	0.043	0.051

PG-TO262-3-1 (I<sup>2</sup> Pak)



<sup>1)</sup> Typical  
 Metal surface min. X = 7.25, Y = 6.9  
 All metal surfaces tin plated, except area of cut.

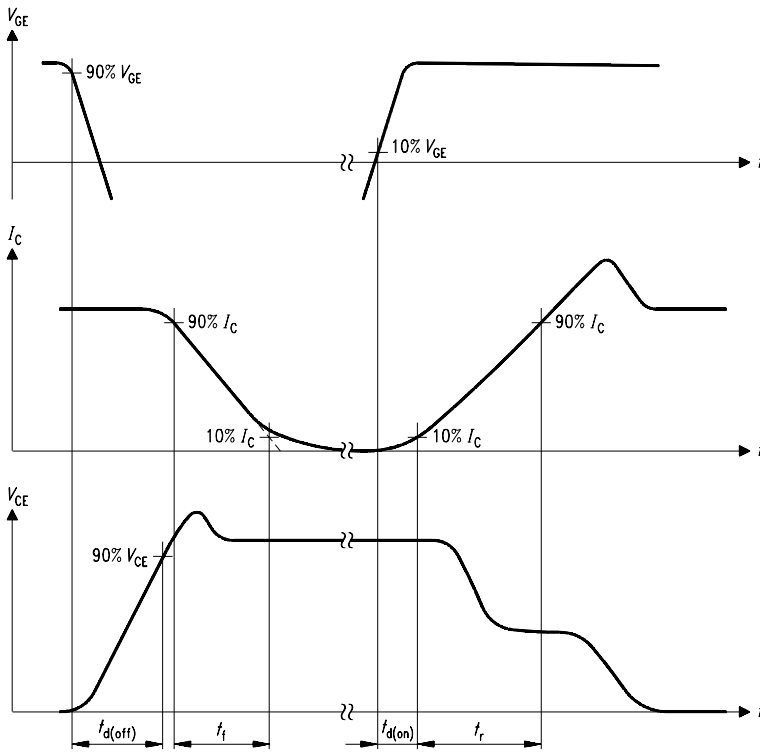


Figure A. Definition of switching times

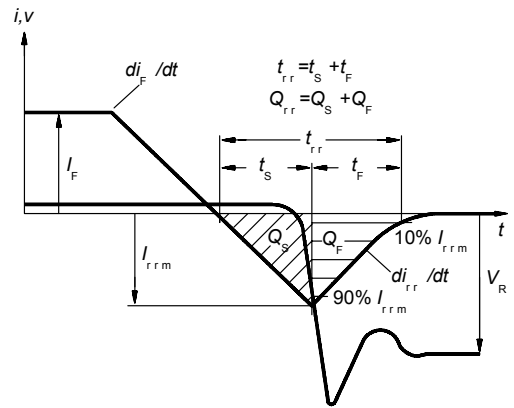


Figure C. Definition of diodes switching characteristics

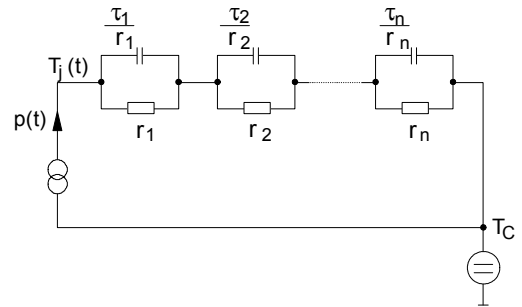


Figure D. Thermal equivalent circuit

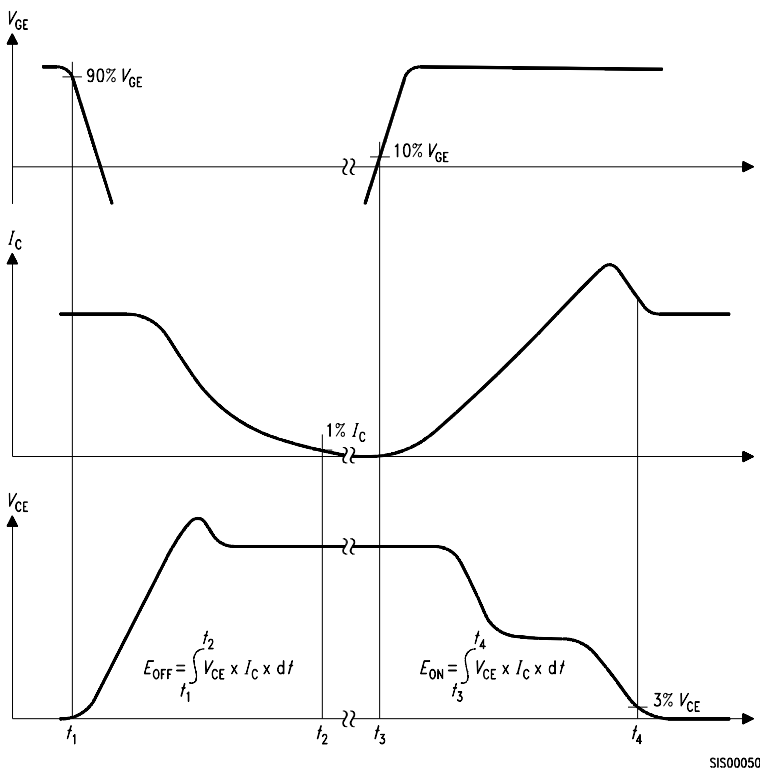


Figure B. Definition of switching losses

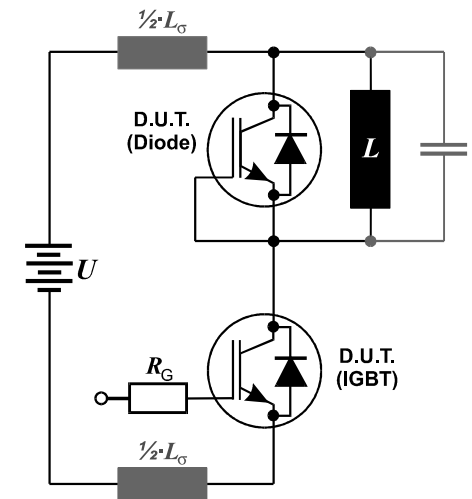


Figure E. Dynamic test circuit  
Leakage inductance  $L_{\sigma}=180\text{nH}$ ,  
and stray capacity  $C_{\sigma}=40\text{pF}$ .

**Edition 2006-01**

**Published by**  
**Infineon Technologies AG**  
**81726 München, Germany**

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